

Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

REMINDERS

- Product information in this catalog is as of October 2010. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or usage of the Products.

Please note that Taiyo Yuden Co., Ltd. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact Taiyo Yuden Co., Ltd. for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.

- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,(automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact Taiyo Yuden Co., Ltd. for more detail in advance. Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

- The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN' s official sales channel"). It is only applicable to the products purchased from any of TAIYO YUDEN' s official sales channel.

- Please note that Taiyo Yuden Co., Ltd. shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from your usage of products in this catalog. Taiyo Yuden Co., Ltd. grants no license for such rights.

- Caution for export

Certain items in this catalog may require specific procedures for export according to "Foreign Exchange and Foreign Trade Control Law" of Japan, "U.S. Export Administration Regulations", and other applicable regulations. Should you have any question or inquiry on this matter, please contact our sales staff.

BALUN TRANSFORMERS



MB: WAVE MC: REFLOW

FEATURES

- High stability due to pair wire windings
- MC type: pins are molded into the base to create a singular structure
- This item can be custom designed to meet customer requirements

APPLICATIONS

- Impedance transformers
- Distribution transformers

OPERATING TEMP.

- -25°C~105°C (Including self-generated heat)

ORDERING CODE

B
U
0
5
M
B
△
0
1
△
△
○

1 Type

BU	Balun transformer
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2 Length of component [mm]

05	5.0, 5.3
06	6.0

3 Shape

MB	pin type
MC	Surface-mount type

4 Product classification code

example	△01
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△=Blank space

5 Packaging

△T	Tape & Reel
△△	Bulk (Only pin type)

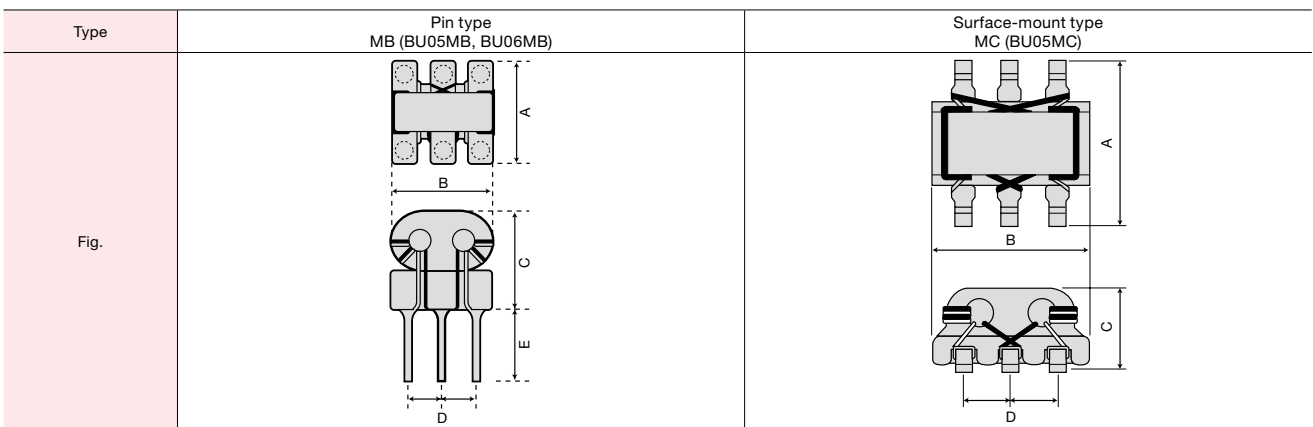
△=Blank space

6 Internal code

△	Standard product
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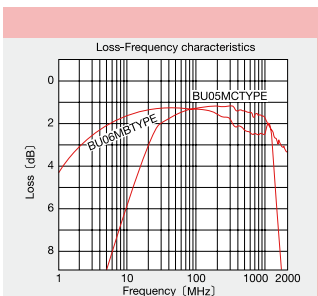
EXTERNAL DIMENSIONS/MINIMUM QUANTITY



Type	A	B	C	D	E	Minimum Quantity (pcs.)		Recommended Land Patterns [BU05MC]
						Box	Taping	
BU05MB	5.5 max. (0.217 max.)	5.5 max. (0.217 max.)	6.0 max. (0.236 max.)	1.75±0.2 (0.069±0.008)	3.5 (0.138)	200	—	
BU06MB	8 max. (0.315 max.)	8 max. (0.315 max.)	8 max. (0.315 max.)	2.25±0.2 pitch (0.089±0.008)	3.5~5.0 (0.138±0.197)	150	—	
BU05MC	5.3±0.5 (0.209±0.020)	5.0±0.3 (0.197±0.012)	2.7±0.2 (0.106±0.008)	1.5±0.2 pitch (0.059±0.008)	—	—	2500	

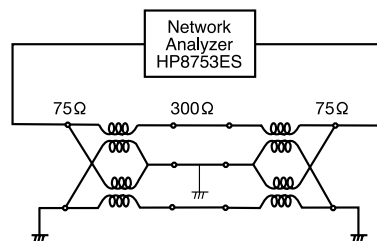
Unit : mm (inch)

ELECTRICAL CHARACTERISTICS



The following chart shows typical ranges for operating characteristics. Please specify the following when ordering.

- ① loss
- ② standing wave ratio (VSWR)
- ③ operating frequency
- ④ specified test circuit



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RELIABILITY DATA

1. Operating Temperature Range													
CM01	-40°C~+105°C												
CM04RC													
BU05MC	-25°C~+105°C												
[Test Method and Remarks] Including self-generated heat													
2. Storage Temperature Range													
CM01													
CM04RC	-40°C~+85°C												
BU05MC													
[Test Method and Remarks] -5 to +40°C in taped packaging													
3. Rated current													
CM01													
CM04RC	Within the specified tolerance.												
BU05MC													
[Test Method and Remarks] The maximum value of DC current within a specified rise of temperature individually.													
4. Impedance													
CM01													
CM04RC	Within the specified tolerance.												
BU05MC													
[Test Method and Remarks] Measuring equipment : HP 4291A or its equivalent Measuring frequency : Specified frequency													
5. DC Resistance													
CM01													
CM04RC	Within the specified tolerance.												
BU05MC													
[Test Method and Remarks] SMD transformer · Common mode choke coil : Measuring equipment : DC ohm meter													
6. Resistance to flexure of substrate													
CM01	Within the specified tolerance.												
CM04RC													
BU05MC	Refer to the individual specification.												
[Test Method and Remarks] According to JIS C 0051													
	<table border="1"> <thead> <tr> <th></th> <th>CM01</th> <th>CM04RC · BU05MC</th> </tr> </thead> <tbody> <tr> <td>Warp</td> <td>2mm</td> <td>3mm</td> </tr> <tr> <td>Pressing speed</td> <td colspan="2">0.5mm/sec.</td> </tr> <tr> <td>Duration</td> <td colspan="2">5±1sec.</td> </tr> </tbody> </table>		CM01	CM04RC · BU05MC	Warp	2mm	3mm	Pressing speed	0.5mm/sec.		Duration	5±1sec.	
	CM01	CM04RC · BU05MC											
Warp	2mm	3mm											
Pressing speed	0.5mm/sec.												
Duration	5±1sec.												
7. Dielectric resistance : between wires													
CM01													
CM04RC	100MΩ min.												
BU05MC													
[Test Method and Remarks] Applied voltage : Rated voltage Duration : 60 sec.													
8. Rated voltage													
CM01													
CM04RC	Within the specification.												
BU05MC													
9. Withstanding voltage : between wires													
CM01													
CM04RC	No abnormality.												
BU05MC													
[Test Method and Remarks] Applied voltage : Regulation voltage, DC250V (CM04RC), DC125V (BU05MC) Duration : 60 sec.													
10. Resistance to vibration													
CM01	No abnormality observed in appearance												
CM04RC													
BU05MC	Refer to the individual specification.												
[Test Method and Remarks] According to JIS C 0040 Directions : 2 hrs each in X, Y, and Z directions. Total : 6 hrs Frequency range : 10 to 55 to 10 Hz (1 min.) Amplitude : 1.5mm (Shall not exceed acceleration 196m/s ²) Mounting method : soldering onto printed board Recovery : At least 2 hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.													

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RELIABILITY DATA

11. Solderability		
CM01	At least 90% of terminal electrode is covered by new solder.	
CM04RC	At least 75% of terminal electrode is covered by new solder.	
BU05MC		
【Test Method and Remarks】		
	CM01	CM04RC・BU05MC
Solder temperature	245±5°C	235±5°C
Duration	3±1sec.	2±0.5sec.
Immersion depth	—	Up to 0.5mm from terminal root

12. Resistance to solder Heat		
CM01	Within the specified tolerance.	
CM04RC	Refer to the individual specification.	
BU05MC		
【Test Method and Remarks】		
	CM01	CM04RC・BU05MC
Reflow soldering	Preheating : 150 to 180°C 1 to 2min	Preheating : 100 to 150°C 1 to 2min
	Peak : 255±5°C 5sec. 230±5°C 30~40sec.	Peak : 230 to 240°C within 5sec. More than 200°C within 40sec.
	Number of reflow : Within 2 times	Number of reflow : Within 2 times
Manual soldering	—	Solder temperature : 350±5°C Duration : 3±1sec. Recovery : 1 to 2hrs of recovery under the standard condition after the test.

13. Thermal shock		
CM01	Within the specified tolerance.	
CM04RC	Refer to the individual specification.	
BU05MC		
【Test Method and Remarks】		
Accoding to JIS C 0025		
Conditions of 1 cycle		
Step	Temperature (°C)	Time (min)
	CM01	CM04RC・BU05MC
1	-40±3°C	-25±3°C
2	Room Temp.	Room Temp.
3	85±2°C	85±3°C
4	Room Temp.	Room Temp.
	CM01	CM04RC・BU05MC
	30±3	3
	30±3	3
	3	3

Number of cycle : CM01 : 100 cycle
CM04RC・BU05MC : 10 cycle

Recovery : Recovery under the standard condition after removal from test chamber.
CM01 : Should be measured within 2 to 48hours.
CM04RC・BU05MC : Leave within 1 to 2 hours.

14. Loading under damp heat		
CM01	Within the specified tolerance.	
CM04RC	Refer to the individual specification.	
BU05MC		
【Test Method and Remarks】		
	CM01	CM04RC・BU05MC
Temperature	60±2°C	40±3°C
Humidity	90~95%RH	
Applied current	Rated current	
Duration	1000±24hrs	
Recovery : Recovery under the standard condition after removal from test chamber. CM01 : Should be measured within 2 to 48hours. CM04RC・BU05MC : Leave within 1 to 2 hours.		

15. High temperature life test	
CM01	—
CM04RC	Refer to the individual specification.
BU05MC	
【Test Method and Remarks】	
	CM04RC・BU05MC
Temperature	85±3°C
Duration	1000±24hrs
Recovery : Recovery under the standard condition after removal from test chamber. CM01 : Should be measured within 2 to 48hours. CM04RC・BU05MC : Leave within 1 to 2 hours.	

16. Low Temperature life Test		
CM01	Within the specified tolerance.	
CM04RC	Refer to the individual specification.	
BU05MC		
【Test Method and Remarks】		
	CM01	CM04RC・BU05MC
Temperature	-40±2°C	-40±3°C
Applied current	1000±24hrs	
Recovery : Recovery under the standard condition after removal from test chamber. CM01 : Should be measured within 2 to 48hours. CM04RC・BU05MC : Leave within 1 to 2 hours.		

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RELIABILITY DATA

17. Loading at high temperature life test

CM01	Within the specified tolerance.
CM04RC	—
BU05MC	—

【Test Method and Remarks】

CM01	
Temperature	105±2°C
Applied current	Rated current
Duration	1000±24hrs

Recovery : Recovery under the standard condition after removal from test chamber.

CM01 : Should be measured within 2 to 48hours.

CM04RC・BU05MC : Leave within 1 to 2 hours.

Note on standard condition :

"standard condition" referred to herein is defined as follows:

5 to 35°C of temperature, 45 to 85% relative humidity and 86 to 106kPa of air pressure.

When there are questions concerning measurement results:

In order to provide correlation data, the test shall be conducted under condition of 20±2°C of temperature, 45 to 85% relative humidity and 86 to 106kPa of air pressure.

Unless otherwise specified, all the tests are conducted under the "standard condition."

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PRECAUTIONS

CM04RC, BU05MC, CM01

1. Circuit Design	
Precautions	<ul style="list-style-type: none"> ◆ Operating environment <ol style="list-style-type: none"> The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.
2. PCB Design	
Precautions	<ul style="list-style-type: none"> ◆ Land pattern design <ol style="list-style-type: none"> Please contact any of our offices for a land pattern, and refer to a recommended land pattern of specifications.
Technical considerations	<ul style="list-style-type: none"> ◆ Land pattern design <ul style="list-style-type: none"> Surface Mounting <ul style="list-style-type: none"> Mounting and soldering conditions should be checked beforehand. Applicable soldering process to these products is reflow soldering only. Recommended Land Patterns <div style="display: flex; justify-content: space-around; align-items: flex-start;"> <div style="text-align: center;"> <p>[CM04RC] (2 Lines)</p> </div> <div style="text-align: center;"> <p>(3 Lines)</p> </div> <div style="text-align: center;"> <p>(4 Lines)</p> </div> <div style="text-align: center;"> <p>[BU05MC]</p> </div> <div style="text-align: center;"> <p>[CM01]</p> </div> </div> <p style="text-align: right;">Unit: mm</p>
3. Considerations for automatic placement	
Precautions	<ul style="list-style-type: none"> ◆ Adjustment of mounting machine <ol style="list-style-type: none"> Excessive impact load should not be imposed on the products when mounting onto the PC boards. Mounting and soldering conditions should be checked beforehand.
Technical considerations	<ul style="list-style-type: none"> ◆ Adjustment of mounting machine <ol style="list-style-type: none"> When installing products, care should be taken not to apply distortion stress as it may deform the products.
4. Soldering	
Precautions	<ul style="list-style-type: none"> ◆ Reflow soldering <ol style="list-style-type: none"> Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified. This product can be used reflow soldering only. Please do not add any stress to a product until it returns in normal temperature after reflow soldering. ◆ Lead free soldering <ol style="list-style-type: none"> When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, soldering etc sufficiently. ◆ Recommended conditions for using a soldering iron <ul style="list-style-type: none"> [CM04RC, BU05MC] <ul style="list-style-type: none"> Put the soldering iron on the land-pattern. Soldering iron's temperature - Below 350°C Duration - 3 seconds or less The soldering iron should not directly touch the inductor. [CM01] <ul style="list-style-type: none"> Please do not conduct an adjustment with a soldering iron because the wire would be broken due to its thinness.
Technical considerations	<ul style="list-style-type: none"> ◆ Reflow soldering <ol style="list-style-type: none"> If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.
5. Cleaning	
Precautions	<ul style="list-style-type: none"> ◆ Cleaning conditions <ol style="list-style-type: none"> Please contact any of our offices for a cleaning.
6. Handling	
Precautions	<ul style="list-style-type: none"> ◆ Handling <ol style="list-style-type: none"> Keep the product away from all magnets and magnetic objects. ◆ Breakaway PC boards (splitting along perforations) <ol style="list-style-type: none"> When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board. Board separation should not be done manually, but by using the appropriate devices. ◆ Mechanical considerations <ol style="list-style-type: none"> Please do not give the product any excessive mechanical shocks. Please do not add any shock and power to a product in transportation. ◆ Pick-up pressure <ol style="list-style-type: none"> Please do not push to add any pressure to a winding part. Please do not give any shock and push onto an exposed part of ferrite cores. ◆ Packing <ol style="list-style-type: none"> Please avoid accumulation of a packing box as much as possible.
Technical considerations	<ul style="list-style-type: none"> ◆ Handling <ol style="list-style-type: none"> There is a case that a characteristic varies with magnetic influence. ◆ Breakaway PC boards (splitting along perforations) <ol style="list-style-type: none"> The position of the product on PCBs shall be carefully considered to minimize the stress caused from splitting of the PCBs. ◆ Mechanical considerations <ol style="list-style-type: none"> There is a case to be damaged by a mechanical shock. There is a case to be broken by the handling in transportation. ◆ Pick-up pressure <ol style="list-style-type: none"> An excessive shock or stress may cause a damage to the product or a deterioration of a characteristic. ◆ Packing <ol style="list-style-type: none"> If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products.
7. Storage conditions	
Precautions	<ul style="list-style-type: none"> ◆ Storage <ol style="list-style-type: none"> To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. <ul style="list-style-type: none"> Recommended conditions Ambient temperature : 0~40°C, Humidity : Below 70% RH <p>The ambient temperature must be kept below 30°C. Even under ideal storage conditions, the solderability of electrodes may decrease gradually. For this reason, the products should be used within one year from the time of delivery. In case of storage over 6 months, solderability shall be checked before actual usage.</p>
Technical considerations	<ul style="list-style-type: none"> ◆ Storage <ol style="list-style-type: none"> Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.

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